TAP2000 Series

Ultra High Power Planar Resistor

The Ohmite TAP2000 series offers 2000 watts of power dissipation when properly heatsinked. The design of the TAP series creates a constant pressure to the cooling plate of approximately 300 N for proper thermal flow. The TAP2000 is ideal for variable speed drives, power supplies, control devices, robotics, motor control and other power designs.

> Max. cont. current 120 A Electric strength 7 kVrr

Partial discharge

Creeping distance

Oper. temperature

Air distance

Inductance

Mounting

Weight ~120 g

Insulation resistance > 10 G Ω at 1,000 V

FEATURES

- 2,000 W operating power with proper heatsinking
- Non-Inductive design
- ROHS compliant
- High insulation & partial discharge performance
- Materials in accordance with UL 94 V-0



Resistance value $0.15\Omega \le 0.99\Omega$ (HC-version); > $0.99\Omega \le 6$ K Ω (higher
values on request)BatResistance tolerance $\pm 5 \%$ to $\pm 10 \%$ EncapTemp. coefficient ± 150 ppm/°C Standard; lower TCR on special
request for limited ohmic valuesEncapPower rating2,000 W at 125° C bottom case temperature resp.
 60° C heat sink temperatureResistanceShort time overload2,400 W at 70° C for 10 sec., $\Delta R = 0.4\%$ max.ResistanceMax. working voltage5,000 V DC = 3.500 V AC RMS (50 Hz); higher voltage on request, not exceeding max. power

7 kVrms / 50 Hz / 500 VA. test time 1 min. between

Voltages above 10 kVrms are tested at DC equiva-

4 kVrms < 10 pC (up to 7 kVrms < 10 pC on request)

voltage terminal und case (up to 12 kVrms on request).

acc. to IEC 60270
Pulse peak current up to 1,500 A depending on pulse length and fre-

Single shot voltage up to 12 kV norm wave (1.5/50 µsec)

-55°C to +155°C

to 1.8 Nm M4 screws

quency (ask for details)

lent to avoid pre damage of component

> 42mm (standard, higher on request)

> 14mm (standard, higher on request)

Capacity/mass ≥ 120 pF (typical), measuring frequency 10 kHz

Capacity/parallel ≥ 40 pF (typical), measuring frequency 10 kHz

≥ 80 nH (typical), measuring frequency 10 kHz

torque for contacts 1.8 Nm to 2 Nm; torque 1.6 Nm

Base Plate	Alumina ceramic metalized film on the base plate for improved heat transfer
Encapsulation	Resin-filled epoxy casing with large creeping distance to mass, large air distance between the terminals and high insulation resistance (CTI 600)
Resistance Element	Special design for low inductance and capacitance values. The element dem- onstrates stability while covering high wattage and pulse loading
Contacts	 Various sleeves for increasing creeping distance up to 85mm Contacts standard M5 (M4 on special request - connection screw thread max. 7mm

Derating



Derating (thermal resist.) 66.6 W/K (0.015 K/W) Power rating: 2,000 W at 125°C bottom case temperature

Please ask for detailed mounting procedure!

Best results can be reached by using a thermal transfer compound with a heat conductivity of at least 2.9 W/mK. The flatness of the cooling plate must be better than 0.05 mm overall. Surface roughness should not exceed 6.4 $\mu m.$

CHARACTERISTICS

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PERFORMANCE DATA

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Test	Method	$\Delta \mathbf{R}$
Short time overload	2,400 W/10sec.	0.40%
Humidity steady	56 days/40°C/95%	0.25%
state		
Temp. Cycling	-55/+125/5cycles	0.20%
Shock	40g/4,000 times	0.25%
Vibrations	2-500Hz/10g	0.25%
Load life	3,000cyl PN 30 min. on / 30 min off	0.40%
Terminal strength	200 N for hexa. thread con-	0.05%
	tacts	
test methods are according	g to IEC 60068-2	

*C to C for (60mm ±.8) Connection screw mounting holes thread max 7mm 2.244" ±.008 (57mm ±.2) 0.71" ±.02 2.244" ±.02 $(18mm \pm .5)$ (57mm ±.5) 1.338" ±.008 (34mm ±.2) 0.2" ±.02 (5mm ±.5) 0 2.56" ±.031 (65mm ±.8) ← 1.417" ±.008 -> (36mm ±.2) 0.276" ±.02 0.197" ±.02 (7mm ±.5) (5mm ±.5) 1.26" ±.02 1.181" ±.02 (32mm ±.5) (30mm ±.5) Air distance: 14mm [0.5512] min. Creeping distance: 42mm [1.6535] min. 0.59" ±.02 (15mm ±.5)

DIMENSIONS

øM5 (DIN) std. (M4 on request)

ø0.16" ±.005

(4.175mm ±.13) 2.36" ±.031

ORDERING INFORMATION

 $\frac{T \ A \ P \ 2 \ 0 \ 0 \ 0}{\underset{\substack{\mathsf{below} \ 1\Omega}}{\mathsf{Formulat}}} \underbrace{H \ C}_{\mathsf{K} = 10\%} \underbrace{K \ 5 \ R \ 0}_{\mathsf{K} \ \mathsf{E}} \underbrace{E}_{\mathsf{Resistance}}$

THIS PRODUCT IS DESIGNED FOR USE WITH PROPER HEATSINKING.

Maximum base plate temperature of the resistor must be monitored and kept within specified limits to establish the power rating. Best technique is to attach a thermocouple to the side of the base plate of the resistor. Temperature of plastic housing or heat sink cannot be used to establish rating of the resistor. The Ohmite CP4 (https://www.ohmite.com/cp4-series-chillplate/) is an example of properly designed heat sink.

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